



# Product Change Notification

**Change Notification #:** 117575 - 00  
**Change Title:** Intel® Server Chassis R2000WFXMLX  
 PCN 117575-00, Label,  
 Update regulatory labels to add NYCE logo  
**Date of Publication:** April 24, 2020

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*:</b>	May 11, 2020
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is updating the regulatory label of the Intel Server Chassis listed in "Products Affected" table, to comply with NYCE certificate mark.

Figure 1. Previous Packaging Box outer label



Figure 2. New Packaging Box outer label



Figure 3. Previous Chassis external label



Figure 4. New Chassis external label



**Customer Impact of Change and Recommended Action:**

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
R2000WFXXX	975897	H97485-005	H97485-006

**PCN Revision History:**

Date of Revision:	Revision Number:	Reason:
April 24, 2020	00	Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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